Notice of Allowability	Application No.	Applicant(s)
	10/038,388	YU ET AL.
	Examiner	Art Unit
	Alonzo Chambliss	2827
The MAILING DATE of this communicated All claims being allowable, PROSECUTION ON THE ME herewith (or previously mailed), a Notice of Allowance (FINOTICE OF ALLOWABILITY IS NOT A GRANT OF PART of the Office or upon petition by the applicant. See 37 CM	PTOL-85) or other appropriate commur	his application. If not included
<ol> <li>This communication is responsive to 1/3/02.</li> <li>The allowed claim(s) is/are 1-4,6 and 8-38.</li> <li>The drawings filed on 03 January 2002 are accept.</li> <li>Acknowledgment is made of a claim for foreign properties of the communication.</li> </ol>	riority under 35 U.S.C. § 119(a)-(d) or ( :	r).
1. Certified copies of the priority docume	ents have been received.	
2.   Certified copies of the priority docume	ents have been received in Application	No
3. Copies of the certified copies of the properties of the proper	.2(a)).  priority under 35 U.S.C. § 119(e) (to a priority application has been received.	provisional application).
Applicant has THREE MONTHS FROM THE "MAILING Delow. Failure to timely comply will result in ABANDONN 7.   A SUBSTITUTE OATH OR DECLARATION must INFORMAL PATENT APPLICATION (PTO 152) which size	be submitted. Note the attached EVAN	HINED'S AMENDMENT AND TOP OF
INFORMAL PATENT APPLICATION (PTO-152) which gi	ves reason(s) why the oath or declarat	inter 5 AMENDMENT OF NOTICE OF ion is deficient.
8. CORRECTED DRAWINGS must be submitted.  (a) including changes required by the Notice of D  1) hereto or 2) to Paper No		
(b) ☐ including changes required by the proposed of	rawing correction filed, which i	nas been approved by the Examiner.
(c) ☐ including changes required by the attached E	xaminer's Amendment / Comment or ir	the Office action of Paper No
Identifying indicia such as the application number (see 3 of each sheet. The drawings should be filed as a separa	7 CFR 1.84(c)) should be written on the of the paper with a transmittal letter address	drawings in the top margin (not the back) ed to the Official Draftsperson.
9. DEPOSIT OF and/or INFORMATION about th attached Examiner's comment regarding REQUIREMENT	e deposit of BIOLOGICAL MATER FOR THE DEPOSIT OF BIOLOGICA	IAL must be submitted. Note the L MATERIAL.
Attachment(s)		
1⊠ Notice of References Cited (PTO-892) 3□ Notice of Draftperson's Patent Drawing Review (PTO-5⊠ Information Disclosure Statements (PTO-1449), Paper 7□ Examiner's Comment Regarding Requirement for Deport Biological Material	$4 \boxtimes$ Interview S r No. $\underline{2}$ . $6 \boxtimes$ Examiner's	formal Patent Application (PTO-152) ummary (PTO-413), Paper No. <u>3</u> . Amendment/Comment Statement of Reasons for Allowance
U.S. Patent and Trademark Office PTO-37 (Rev. 04-01)	Notice of Allowability	Part of Paner No. 4

Notice of Allowability

Part of Paper No. 4

Application/Control Number: 10/038,388

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## **DETAILED ACTION**

## **EXAMINER'S AMENDMENT**

1. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Stephen B. Ackerman on February 18, 2003.

2. The application has been amended as follows:

## **IN CLAIMS:**

Cancel claim 5.

In claim 14, line 1, delete " 1 " and insert instead -- 4 --;

In claim 25, line 51, after "solder bump," insert - while simultaneously --.

## Allowable Subject Matter

3. The following is a statement of reasons for the indication of allowable subject matter: the prior art of record does not teach or suggest the combination of a depositing a layer of elastomer over a partially exposed surface of a layer of passivation and conductive layer overlying a contact pad on a semiconductor substrate. Patterning and etching the layer of elastomer creating an opening in the layer of elastomer that aligns with and exposes the surface of the conductive layer overlying the contact pad.

Depositing a layer of solder over the exposed surface of the conductive layer.

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Performing a reflow process and simultaneously curing the deposited layer of solder and patterned etched layer of elastomer.

Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (703) 306-9143. The fax phone number for this Group is (703) 308-7722 or 7724.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the group receptionist whose telephone number is (703) 308-7956.

DAVID L. TALBOTT SUPERVISORY PATRET EXAMINER TECHNOLOGY CENTER 2800

AC

**AC/February 18, 2003**